



STB30NM60N, STI30NM60N, STF30NM60N STP30NM60N, STW30NM60N

N-channel 600 V, 0.1 Ω , 25 A, MDmesh™ II Power MOSFET
TO-220, TO-220FP, TO-247, D²PAK, I²PAK

Features

Type	V_{DSS} @ T_{Jmax}	$R_{DS(on)}$ max	I_D	P_W
STB30NM60N	650 V	<0.13 Ω	25A	190 W
STI30NM60N	650 V	<0.13 Ω	25A	190 W
STF30NM60N	650 V	<0.13 Ω	25A ⁽¹⁾	40 W
STP30NM60N	650 V	<0.13 Ω	25A	190 W
STW30NM60N	650 V	<0.13 Ω	25A	190 W

1. Limited only by maximum temperature allowed
- 100% avalanche tested
 - Low input capacitance and gate charge
 - Low gate input resistance

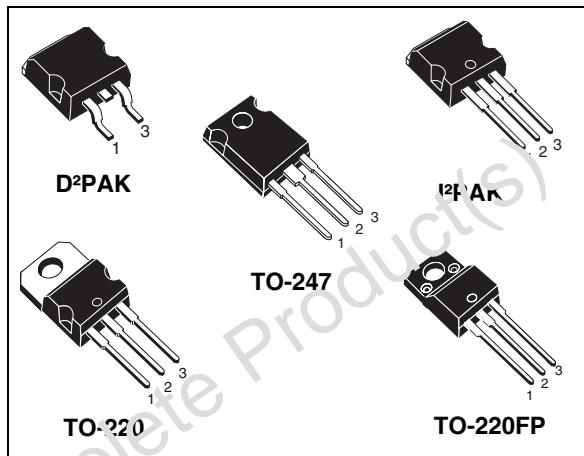


Figure 1. Internal schematic diagram

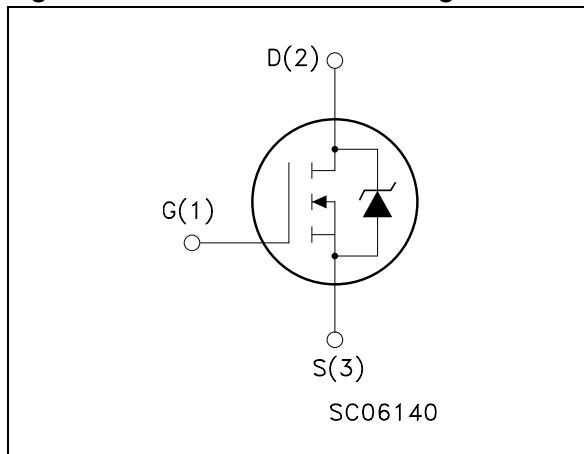


Table 1. Device summary

Order codes	Marking	Package	Packaging
STB30NM60N	30NM60N	D ² PAK	Tape and reel
STI30NM60N	30NM60N	I ² PAK	Tube
STF30NM60N	30NM60N	TO-220FP	Tube
STP30NM60N	30NM60N	TO-220	Tube
STW30NM60N	30NM60N	TO-247	Tube

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value					Unit
		TO-220	I ² PAK	TO-247	D ² PAK	TO-220FP	
V _{DS}	Drain-source voltage ($V_{GS}=0$)			600			V
V _{GS}	Gate-source voltage			± 30			V
I _D	Drain current (continuous) at $T_C = 25^\circ\text{C}$			25		25 ⁽¹⁾	A
I _D	Drain current (continuous) at $T_C = 100^\circ\text{C}$			15.8		15.8 ⁽¹⁾	A
I _{DM} ⁽²⁾	Drain current (pulsed)			100		100 ⁽¹⁾	A
P _{TOT}	Total dissipation at $T_C = 25^\circ\text{C}$			190		40	W
dv/dt ⁽³⁾	Peak diode recovery voltage slope			15			V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink ($t=1\text{ s}; T_C=25^\circ\text{C}$)		--			2500	V
T _{stg}	Storage temperature			-55 to 150			°C
T _j	Max. operating junction temperature			150			°C

- 1. Limited only by maximum temperature allowed
- 2. Pulse width limited by safe operating area
- 3. $I_{SD} \leq 25\text{A}$, $dV/dt \leq 400\text{A}/\mu\text{s}$, $V_{DD} = 80\%$ $V_{(BR)DSS}$

Table 3. Thermal data

Symbol	Parameter	TO-220	I ² PAK	TO-247	D ² PAK	TO-220FP	Unit
R _{thj-case}	Thermal resistance junction-case max			0.66		3.1	°C/W
R _{thj-pcb}	Thermal resistance junction-pcb max	--	--	--	30	--	°C/W
R _{thj-amb}	Thermal resistance junction-amb max	62.5		50	--	62.5	°C/W
T _I	Maximum lead temperature for soldering purposes			300			°C

Table 4. Avalanche characteristics

Symbol	Parameter	Max value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T _j max)	12	A
E _{AS}	Single pulse avalanche energy (starting T _j = 25°C, I _D = I _{AR} , V _{DD} = 50V)	900	mJ

2 Electrical characteristics

(T_{case} =25°C unless otherwise specified)

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating V _{DS} = Max rating, T _C =125°C			1 100	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			100	nA
V _{GS(th)}	Gate threshold voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 12.5 A		0.1	0.13	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	V _{DS} = 10 V, I _D = 12.5 A		25		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 50 V, f = 1 MHz, V _{GS} = 0		2700 210 22		pF pF pF
C _{oss eq.}	Equivalent Output capacitance	V _{GS} = 0, V _{DS} = 0 to 480 V		66		pF
R _g	Gate input resistance	f=1MHz Gate DC Bias=0 Test signal level=20 mV open drain		3		Ω
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =480 V, I _D = 25 A, V _{GS} = 10 V <i>(see Figure 19)</i>		91 14 50		nC nC nC

1. Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Typ.	Max	Unit
$t_{d(on)}$	Turn-on delay time			20		ns
t_r	Rise time			24		ns
$t_{d(off)}$	Turn-off-delay time	$V_{DD} = 300 \text{ V}$, $I_D = 12.5 \text{ A}$, $R_G = 4.7 \Omega$, $V_{GS} = 10 \text{ V}$ (see Figure 18)		125		ns
t_f	Fall time			70		ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Typ.	Max	Unit
I_{SD}	Source-drain current				25	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				100	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 25 \text{ A}$, $V_{GS} = 0$			1.3	V
t_{rr}	Reverse recovery time	$I_{SD} = 25 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$		540		ns
Q_{rr}	Reverse recovery charge			10		μC
I_{RRM}	Reverse recovery current	$V_{DD} = 100 \text{ V}$ (see Figure 23)		36		A
t_{rr}	Reverse recovery time	$I_{SD} = 25 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$		630		ns
Q_{rr}	Reverse recovery charge	$V_{DD} = 100 \text{ V}$, $T_j = 150^\circ\text{C}$		12		μC
I_{RRM}	Reverse recovery current	(see Figure 23)		36		A

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220 / D²PAK / I²PAK

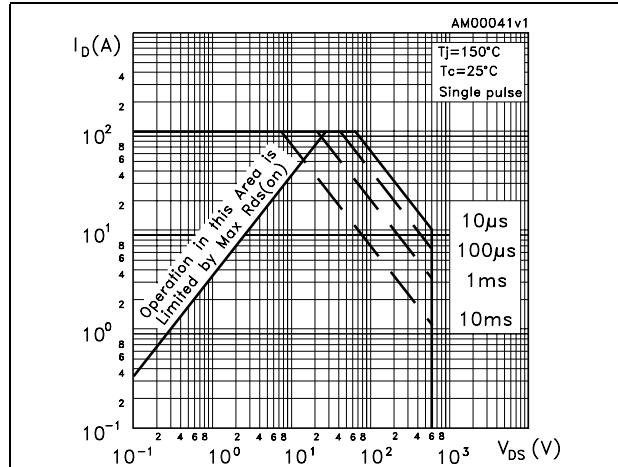


Figure 4. Safe operating area for TO-220FP

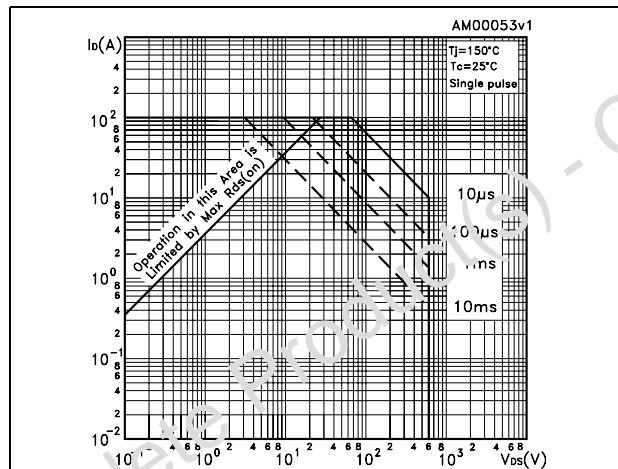


Figure 5. Thermal impedance for TO-220 / D²PAK / I²PAK

Figure 3. Thermal impedance for TO-220 / D²PAK / I²PAK

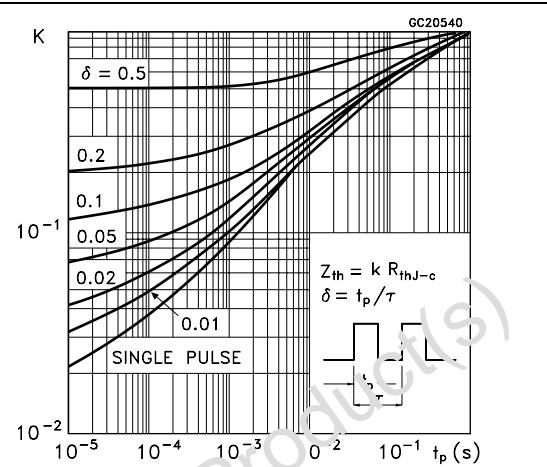


Figure 5. Thermal impedance for TO-220FP

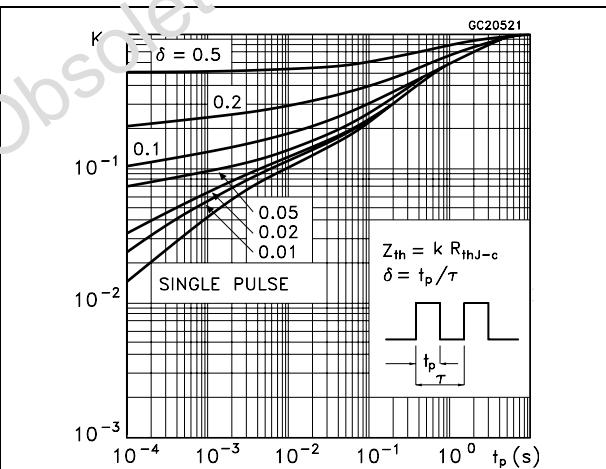
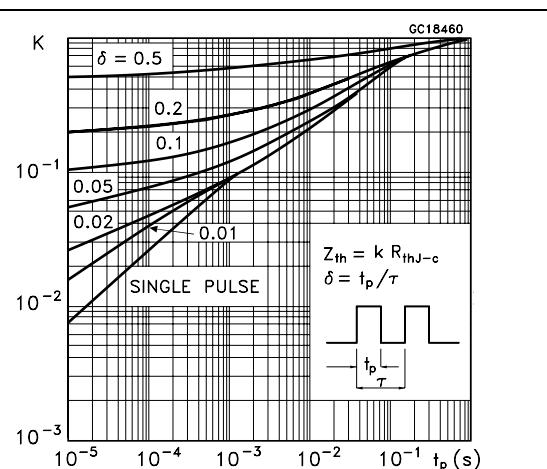
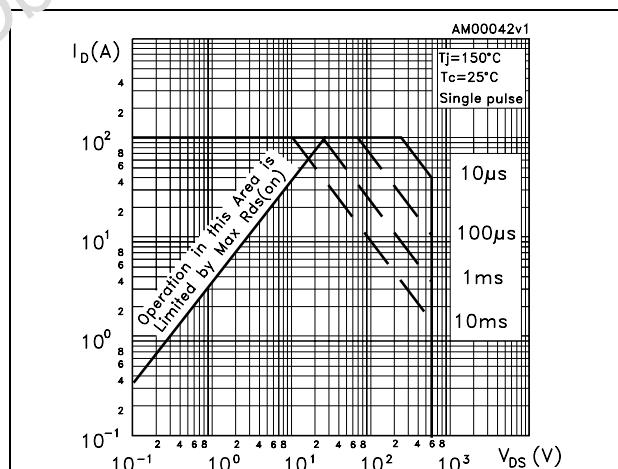


Figure 6. Safe operating area for TO-247

Figure 7. Thermal impedance for TO-247



STB30NM60N,STI30NM60N,STF30NM60N,STP30NM60N,STW30NM60N Electrical characteristics

Figure 8. Output characteristics

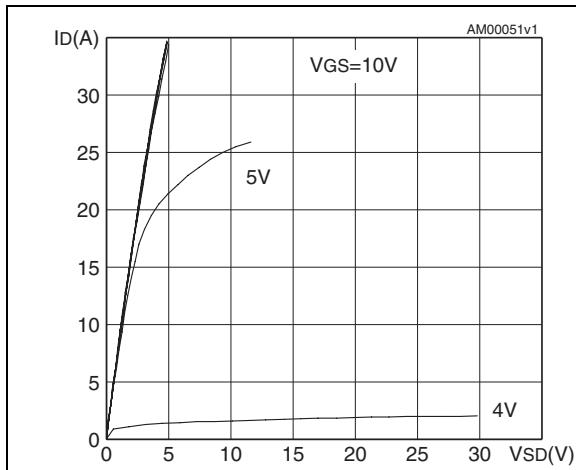


Figure 9. Transfer characteristics

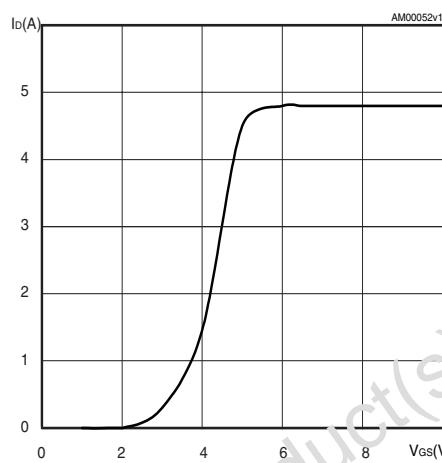


Figure 10. Transconductance

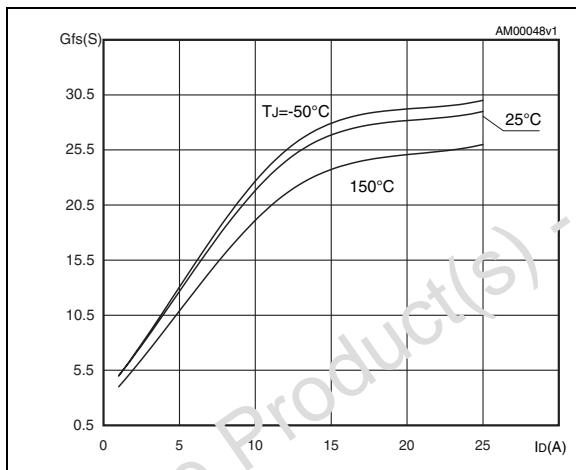


Figure 11. Static drain-source on resistance

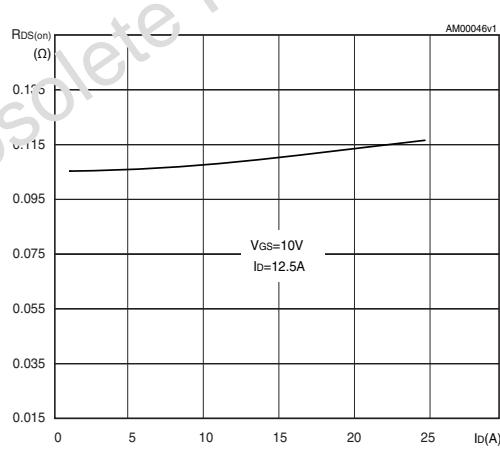


Figure 12. Gate charge vs gate-source voltage **Figure 13. Capacitance variations**

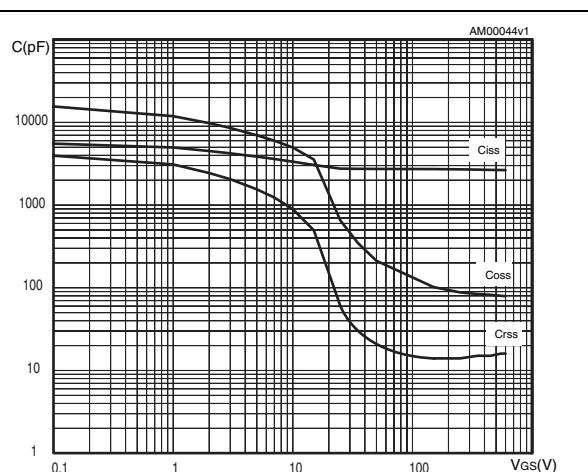
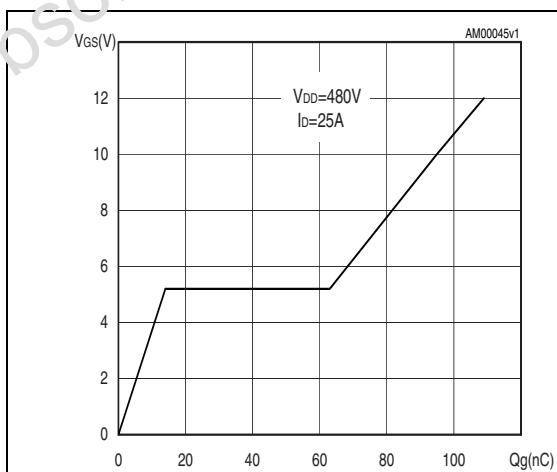


Figure 14. Normalized gate threshold voltage vs temperature

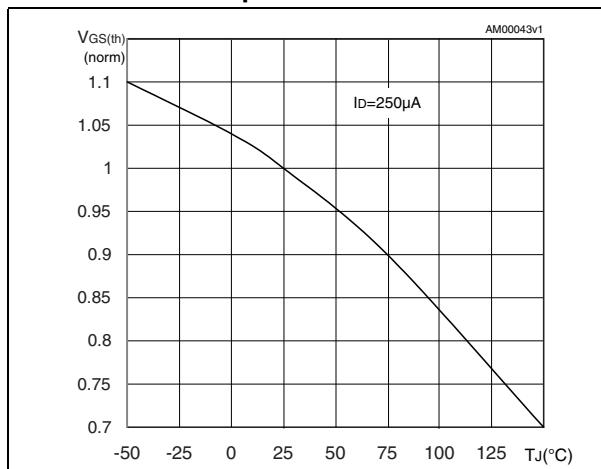


Figure 15. Normalized on resistance vs temperature

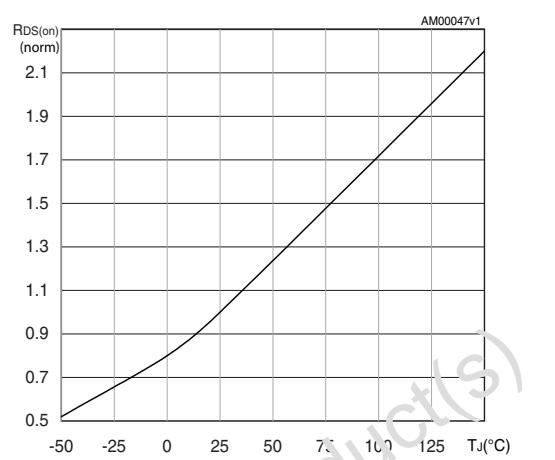


Figure 16. Source-drain diode forward characteristics

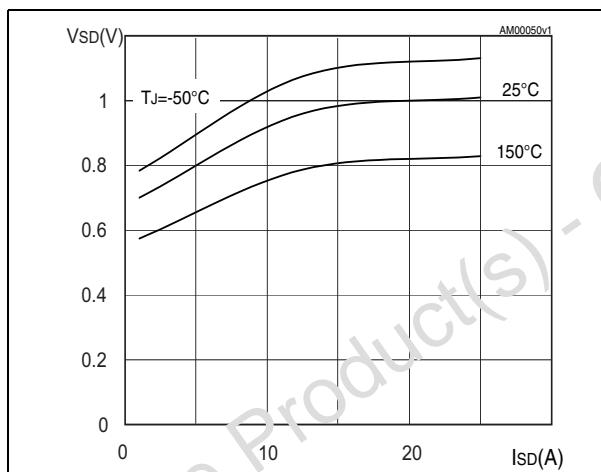
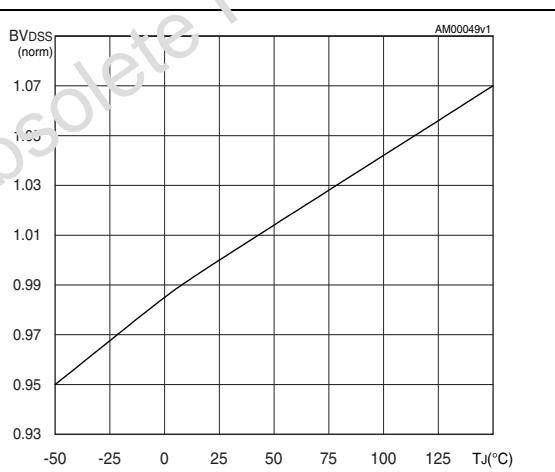


Figure 17. Normalized BV_{DSS} vs temperature



3 Test circuits

Figure 18. Switching times test circuit for resistive load

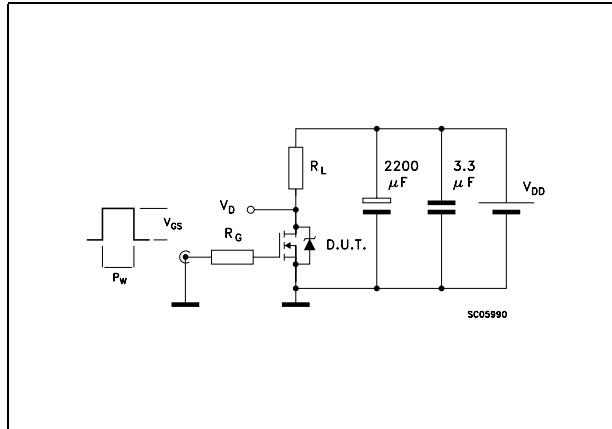


Figure 20. Test circuit for inductive load switching and diode recovery times

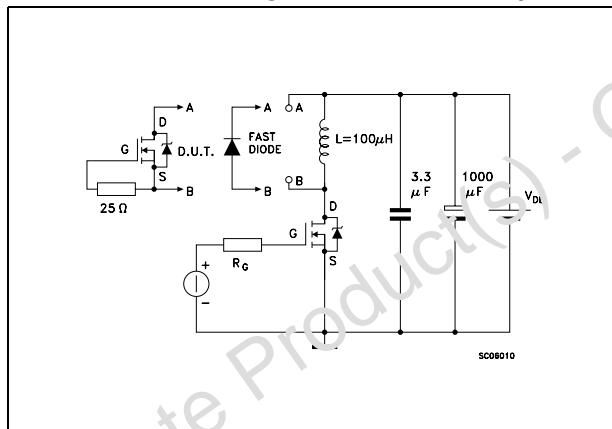


Figure 22. Unclamped inductive waveform

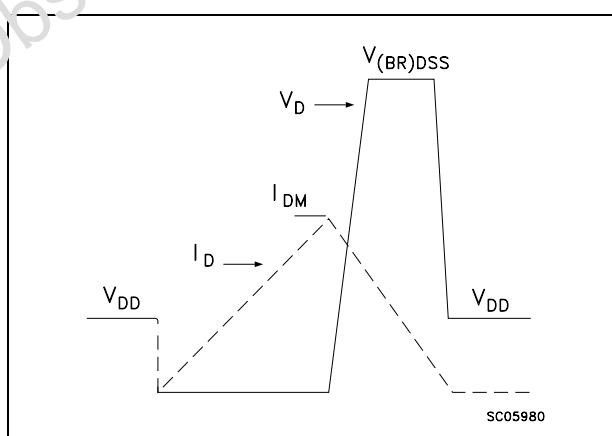


Figure 19. Gate charge test circuit

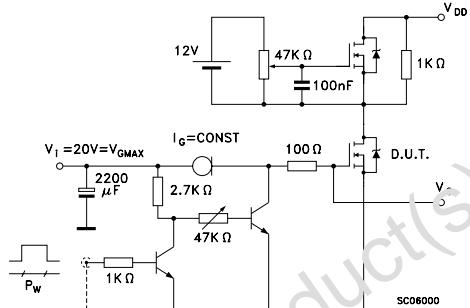


Figure 21. Unclamped inductive load test circuit

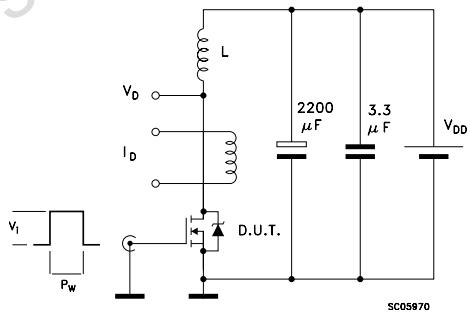
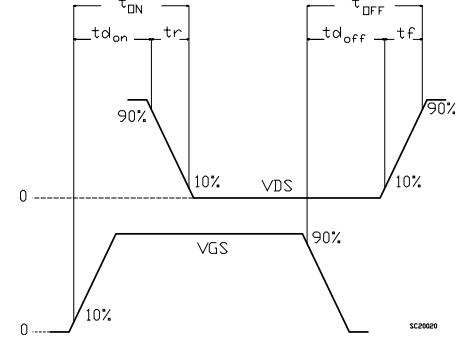


Figure 23. Switching time waveform

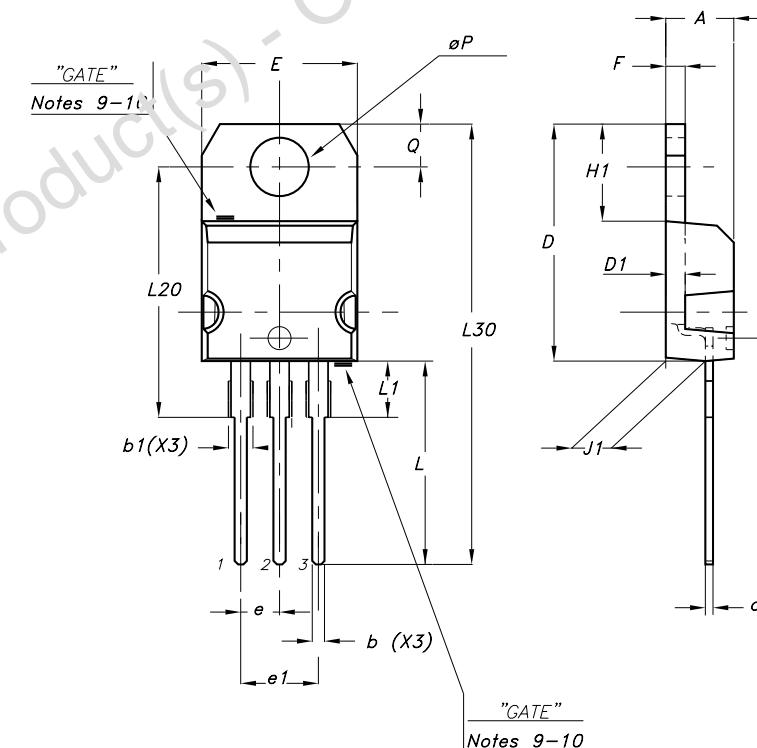


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

TO-220 mechanical data

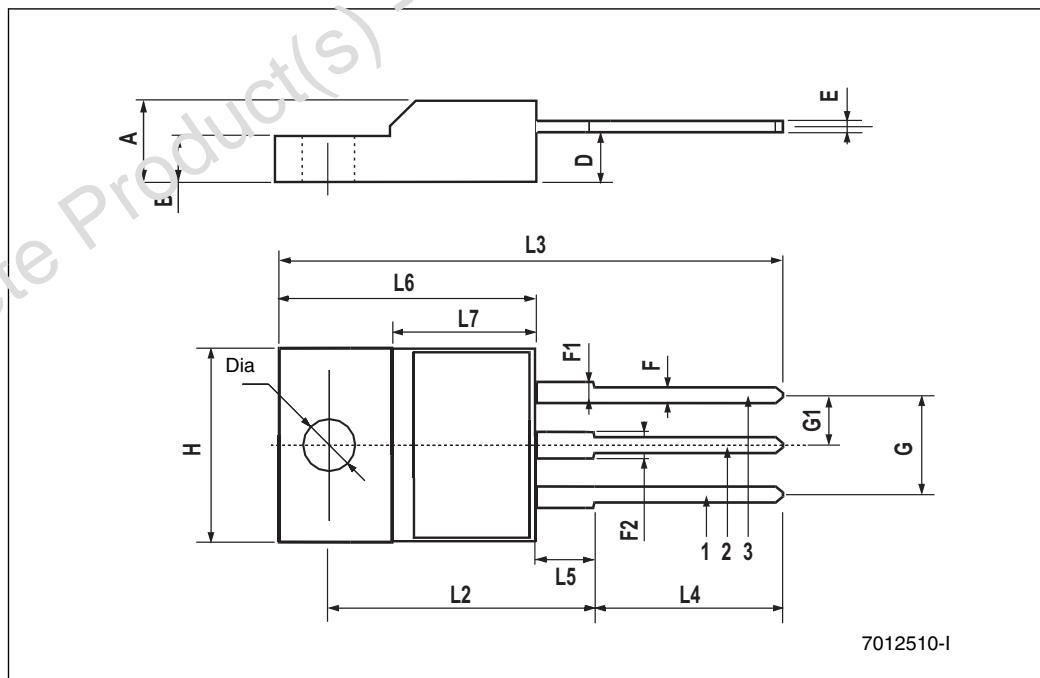
Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
c	0.48		0.70	0.019		0.027
D	15.25		15.75	0.6		0.62
D1		1.27			0.050	
E	10		10.40	0.393		0.409
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.51		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
$\emptyset P$	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



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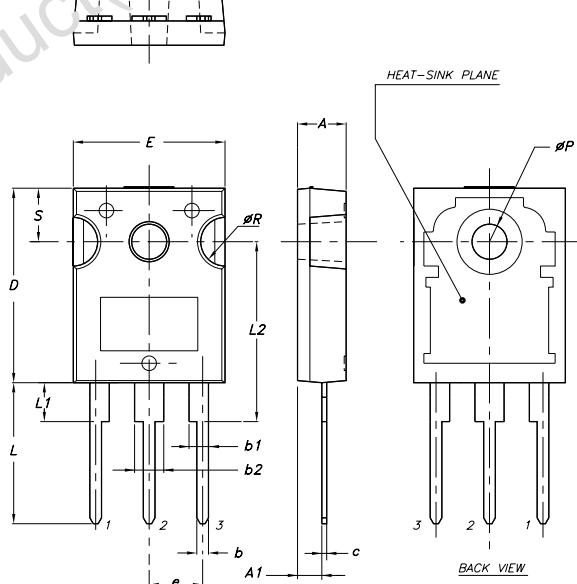
TO-220FP mechanical data

Dim.	mm.			inch		
	Min.	Typ	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.70	0.017		0.027
F	0.75		1.00	0.030		0.039
F1	1.15		1.50	0.045		0.067
F2	1.15		1.50	0.045		0.067
G	4.95		5.20	0.195		0.204
G1	2.40		2.70	0.094		0.106
H	10		10.40	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.80		10.60	0.385		0.417
L5	2.9		3.6	0.14		0.141
L6	15.90		16.40	0.626		0.645
L7	9		9.30	0.354		0.366
Dia	3		3.2	0.118		0.126



TO-247 Mechanical data

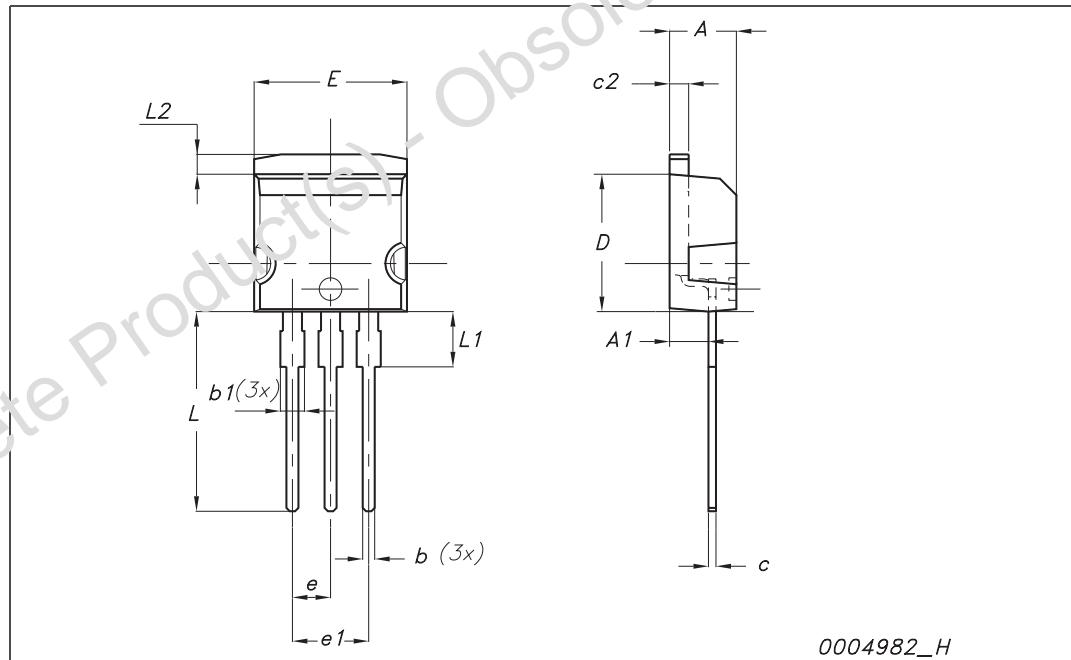
Dim.	mm.		
	Min.	Typ	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15
E	15.45		15.75
e		5.45	
L	14.20		14.80
L1	3.70		4.30
L2		15.50	
ϕP	3.55		3.65
ϕR	4.50		5.50
S		5.50	



0075325 F

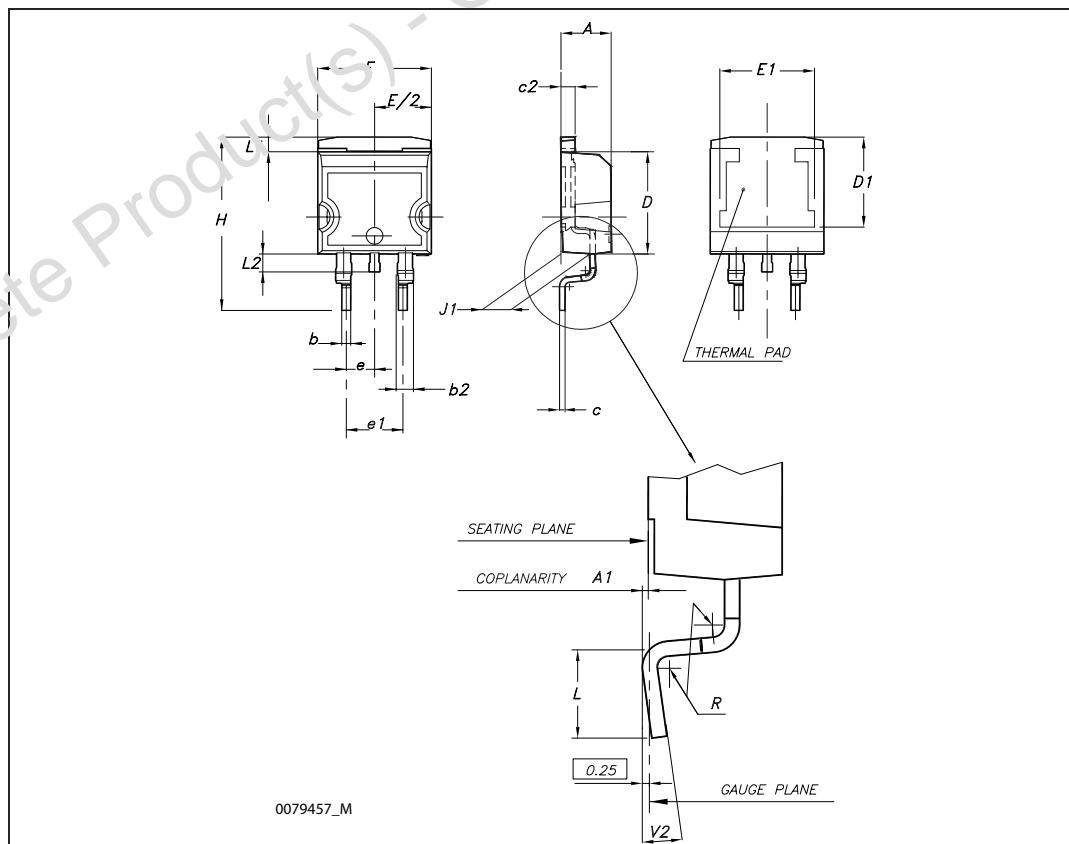
I²PAK (TO-262) mechanical data

Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
A1	2.40		2.72	0.094		0.107
b	0.61		0.88	0.024		0.034
b1	1.14		1.70	0.044		0.066
c	0.49		0.70	0.019		0.027
c2	1.23		1.32	0.048		0.052
D	8.95		9.35	0.352		0.368
e	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
E	10		10.40	0.393		0.410
L	13		14	0.51		0.551
L1	3.50		3.93	0.137		0.154
L2	1.27		1.40	0.050		0.055



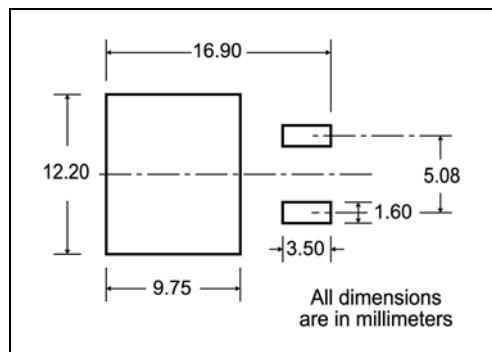
D²PAK (TO-263) mechanical data

Dim	mm			inch		
	Min	Typ	Max	Min	Typ	Max
A	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.027		0.037
b2	1.14		1.70	0.045		0.067
c	0.45		0.60	0.017		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.363
D1	7.50			0.295		
E	10		10.40	0.394		0.409
E1	8.50			0.334		
e		2.54			0.1	
e1	4.88		5.28	0.192		0.208
H	15		15.85	0.590		0.624
J1	2.49		2.69	0.099		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.05		0.055
L2	1.30		1.75	0.051		0.069
R		0.4			0.016	
V2	0°		8°	0°		8°



5 Packaging mechanical data

D²PAK FOOTPRINT



TAPE AND REEL SHIPMENT

REEL MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A		330		12.992
B	1.5		0.059	
C	12.8	13.2	0.504	0.520
D	20.2		0795	
G	24.4	26.4	0.960	1.039
N	100		3.937	
T		30.4		1.197

BASE QTY BULK QTY

1000	1000
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TAPE MECHANICAL DATA

DIM.	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A ₀	10.5	10.7	0.413	0.421
B ₀	15.7	15.9	0.618	0.626
D	1.5	1.6	0.059	0.063
D ₁	1.59	1.61	0.062	0.063
E	1.65	1.85	0.065	0.073
F	11.4	11.6	0.449	0.456
K ₀	4.8	5.0	0.189	0.197
P ₀	3.9	4.1	0.153	0.161
P ₁	11.9	12.1	0.468	0.476
P ₂	1.9	2.1	0.075	0.082
R	50		1.574	
T	0.25	0.35	0.0098	0.0137
W	23.7	24.3	0.933	0.956

* on sales type

6 Revision history

Table 9. Document revision history

Date	Revision	Changes
23-Oct-2007	1	First release.
09-Jul-2008	2	Document status promoted: from preliminary data to datasheet.

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